# 1-Channel Ultra Small 0201 Package ESD Protection Device in 0201

# Description

The CM1242-07CP is a 2-bump ESD protection device in 0201 form factor. It is fully compliant with IEC 61000-4-2. The CM1242-07CP is also RoHS II compliant and has a pure tin finish.

### **Features**

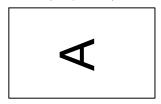
- Low Capacitance < 5.8 pF
- Low Clamping Voltage
- Small Body Outline Dimensions:0.60 mm x 0.30 mm
- Low Body Height: 0.275 mm
- Stand-off Voltage: ±5.0 V
- Low Dynamic Resistance:  $< 1.5 \Omega$
- IEC61000-4-2 Level 4 ESD Protection
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

# **Table 1. PIN DESCRIPTIONS**

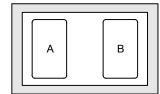
Pin	Description
Α	ESD Channel Pin 1
В	ESD Channel Pin 2

# **PACKAGE / PINOUT DIAGRAMS**

Top View (Bumps Down)



Bottom View (Bumps Up)





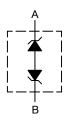
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WLCSP2 CP SUFFIX CASE 567AV

# **BLOCK DIAGRAM**



### **MARKING DIAGRAM**



A = Specific Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
CM1242-07CP		10,000/Tape & Reel
	(Pb-Free)	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

# **SPECIFICATIONS**

**Table 2. STANDARD OPERATING CONDITIONS** 

Parameter	Rating	Units
Storage Temperature Range	-55 to +150	°C
Operating Temperature Range	-40 to +85	°C
Maximum Input Voltage	±5.5	V

Table 3. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
V <sub>B</sub>	Breakdown Voltage	I <sub>F</sub> = +1.0 mA I <sub>F</sub> = -1.0 mA	6.0 -9.0	7.6 -7.6	9.0 -6.0	V
I <sub>LEAK</sub>	Channel Leakage Current	V <sub>IN</sub> = ±5.0 V		±1.0	±100	nA
C <sub>IN</sub>	Channel Input Capacitance	At 1 MHz, V <sub>IN</sub> = 0 V	4.6	5.8	7.0	pF
V <sub>ESD</sub>	ESD Protection Peak Discharge Voltage at any channel input  a) Contact Discharge per IEC 61000-4-2 standard b) Air Discharge per IEC 61000-4-2 standard	(Note 2)	±17 ±17			kV
V <sub>CL</sub>	Channel Clamp Voltage Positive Transients Negative Transients	$I_{PP} = 1 \text{ A, } t_p = 8/20  \mu\text{s}$		+9.8 -9.8		V
R <sub>DYN</sub>	Dynamic Resistance Positive Transients Negative Transients	I <sub>PP</sub> = 1 A, t <sub>p</sub> = 8/20 μs		1.5 1.5		Ω

- T<sub>A</sub> = 25°C unless otherwise specified.
   Standard IEC 61000-4-2 with C<sub>Discharge</sub> = 150 pF, R<sub>Discharge</sub> = 330 Ω.

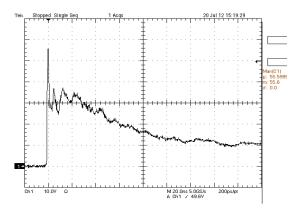


Figure 1. ESD Clamping Voltage Screenshot Positive 8 kV Contact per IEC61000-4-2

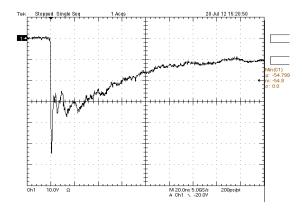


Figure 2. ESD Clamping Voltage Screenshot Negative 8 kV Contact per IEC61000-4-2

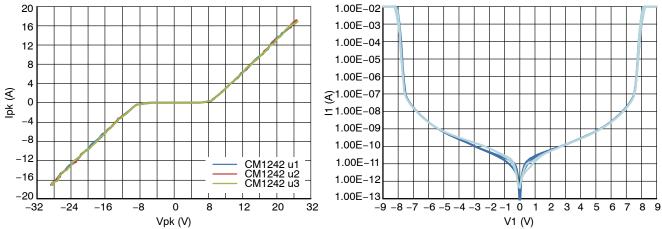


Figure 3. TLP Characteristics

Figure 4. IV Characteristics

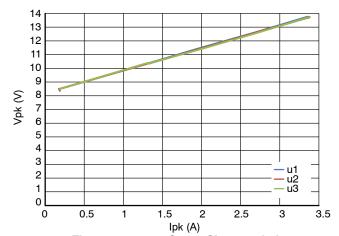


Figure 5. 80 x 20 Surge Characteristics

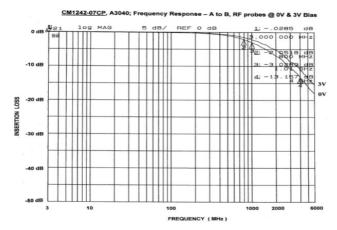


Figure 6. Typical Insertion Loss (S21)

# **MECHANICAL SPECIFICATIONS**

# CM1242-07CP Mechanical Specifications

The CM1242-07CP is supplied in a 2-bump custom package. Dimensions are presented below.

# **Table 4. TAPE AND REEL SPECIFICATIONS**

	Part Number	Chip Size (mm)	Pocket Size (mm) B <sub>0</sub> X A <sub>0</sub> X K <sub>0</sub>	Tape Width W	Reel Diameter	Qty per Reel	P <sub>0</sub>	P <sub>1</sub>
(	CM1242-07CP	0.60 X 0.30 X 0.275	0.67 X 0.37 X 0.35	8 mm	178 mm (7")	10,000	4 mm	2 mm

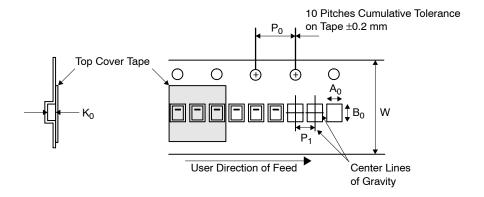


Figure 7. Tape and Reel Mechanical Data

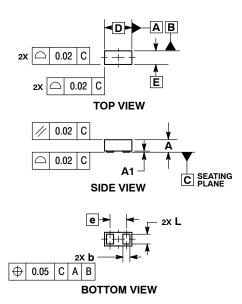
# CM1242-07CP Board Level Application.

Refer to Application Note AND8398/D - Board Level Application Note for 0201 DSN2 Package.



WLCSP2, 0.6x0.3 CASE 567AV ISSUE C

**DATE 22 SEP 2017** 



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.

	MILLIMETERS					
DIM	MIN	IN NOM MAX				
Α	0.250	0.250 0.275 0.300				
A1	0.000 0.025 0.050					
b	0.140 0.155 0.170					
D	0.570	0.600	0.630			
Е	0.270 0.300 0.330					
е	0.36 BSC					
L	0.190 0.215 0.240					

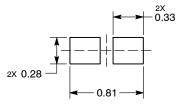
# **GENERIC MARKING DIAGRAM\***



= Specific Device Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.

# **RECOMMENDED SOLDER FOOTPRINT\***



**DIMENSIONS: MILLIMETERS** 

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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